

# P-Channel 20 V (D-S) MOSFET

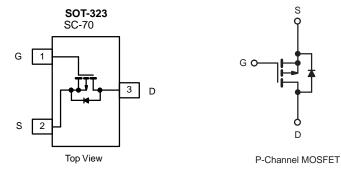
PRODUCT SUMMARY						
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>c</sup>	Q <sub>g</sub> (Typ.)			
- 20	0.080 at V <sub>GS</sub> = - 4.5 V	- 3.1	4.3 nC			
- 20	0.100 at V <sub>GS</sub> = - 2.5 V	- 2.3	4.5110			

#### **FEATURES**

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>g</sub> Tested
  Compliant to RoHS Directive 2002/95/EC

### **APPLICATIONS**

- · Load Switch
- DC/DC Converters



Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V <sub>DS</sub>	- 20	V		
Gate-Source Voltage		V <sub>GS</sub>	± 12	V	
	T <sub>C</sub> = 25 °C		- 3.1		
Continuous Drain Current (T <sub>1</sub> = 150 °C)	T <sub>C</sub> = 70 °C		- 2.1		
$Continuous Drain Current (1) = 150^{\circ}C)$	T <sub>A</sub> = 25 °C	I <sub>D</sub>	- 1.4 <sup>a, b</sup>		
	T <sub>A</sub> = 70 °C		- 1.1 <sup>a, b</sup>	А	
Pulsed Drain Current		I <sub>DM</sub>	- 6		
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C		- 0.4		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	- 0.3		
	T <sub>C</sub> = 25 °C		0.5		
Maximum Davies Dissignation	T <sub>C</sub> = 70 °C		0.3	w	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	0.4 <sup>a, b</sup>	VV	
	T <sub>A</sub> = 70 °C		0.3 <sup>a, b</sup>		
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 50 to 150	℃		
Soldering Recommendations (Peak Temperature)		260			

a. Surface mounted on 1" x 1" FR4 board.

b. t = 10 s.

c. Based on  $T_C = 25$  °C.



Parameter	Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>a, b</sup>	t ≤ 10 s	R <sub>thJA</sub>	250	300	°C/W
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	225	270	C/W

Notes:

a. Surface mounted on 1" x 1" FR4 board.

b. Maximum under steady state conditions is 360 °C/W.

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Static	Cymbol			199.	max.	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = - 250 μA	- 20		1	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$			- 14		- mV/°C
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = - 250 μA		2.4		
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = - 250 μA	- 0.45		- 1.5	V
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 8 V$			± 100	nA
Ū	655	$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}$			- 1	μA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$			- 10	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	- 2			А
	D(01)	V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 1.4 A		0.080		Ω
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 2.5 V, I <sub>D</sub> = - 1.2 A		0.120		
	20(01)	V <sub>GS</sub> = - 1.8 V, I <sub>D</sub> = - 0.3 A		0.140		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = -5 V, I_D = -1.4 A$		5		S
Dynamic <sup>b</sup>	-10		1	•	•	
Input Capacitance	C <sub>iss</sub>			272		pF
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = - 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz		55		
Reverse Transfer Capacitance	C <sub>rss</sub>			44		
	Qg	$V_{DS} = -10 \text{ V}, \text{ V}_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -1.4 \text{ A}$		4.3	6.5	nC
Total Gate Charge				2.7	4.1	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> = - 10 V, V <sub>GS</sub> = - 2.5 V, I <sub>D</sub> = - 1.4 A		0.7		
Gate-Drain Charge	Q <sub>ad</sub>			1.0		
Gate Resistance	R <sub>q</sub>	f = 1 MHz	1.4	7	14	Ω
Turn-On Delay Time	t <sub>d(on)</sub>			12	20	
Rise Time	t <sub>r</sub>	V <sub>DD</sub> = - 10 V, R <sub>I</sub> = 9.1 Ω		20	30	- ns
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong -1.1 \text{ A}, \text{ V}_{\text{GEN}} = -4.5 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$		23	35	
Fall Time	t <sub>f</sub>			9	18	
Turn-On Delay Time	t <sub>d(on)</sub>			5	10	
Rise Time	t <sub>r</sub>	$V_{DD} = -10 \text{ V}, \text{ R}_{1} = 9.1 \Omega$		10	20	
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong$ - 1.1 A, $V_{GEN}$ = -8 V, $R_g$ = 1 $\Omega$		18	27	
Fall Time	t <sub>f</sub>			7	14	
Drain-Source Body Diode Characterist	ics	•		•	•	
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C			- 2.4	
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				- 6	A
Body Diode Voltage	V <sub>SD</sub>	I <sub>F</sub> = - 0.7 A		- 0.8	- 1.2	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>			18	27	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	$\Omega_{rr}$ I <sub>E</sub> = -0.7 A. dl/dt = 100 A/us. T <sub>1</sub> = 25 °C		7	14	nC
Reverse Recovery Fall Time	t <sub>a</sub>			7		1
Reverse Recovery Rise Time	t <sub>b</sub>	1		11		ns

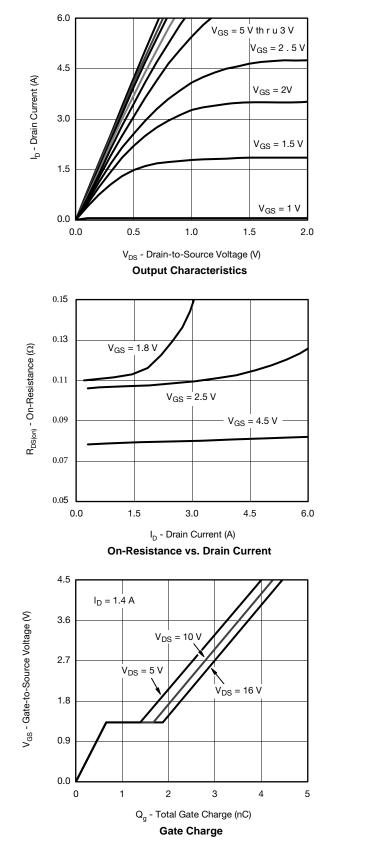
Notes:

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

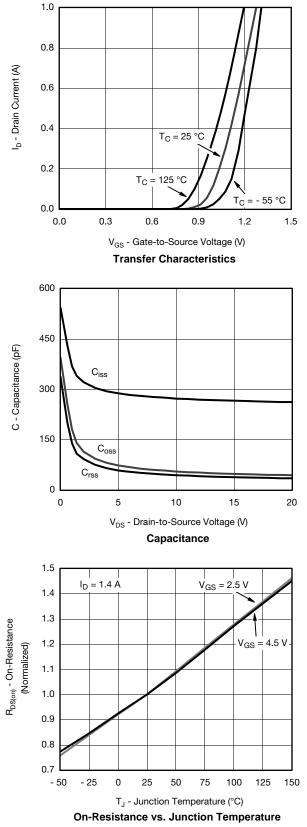
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





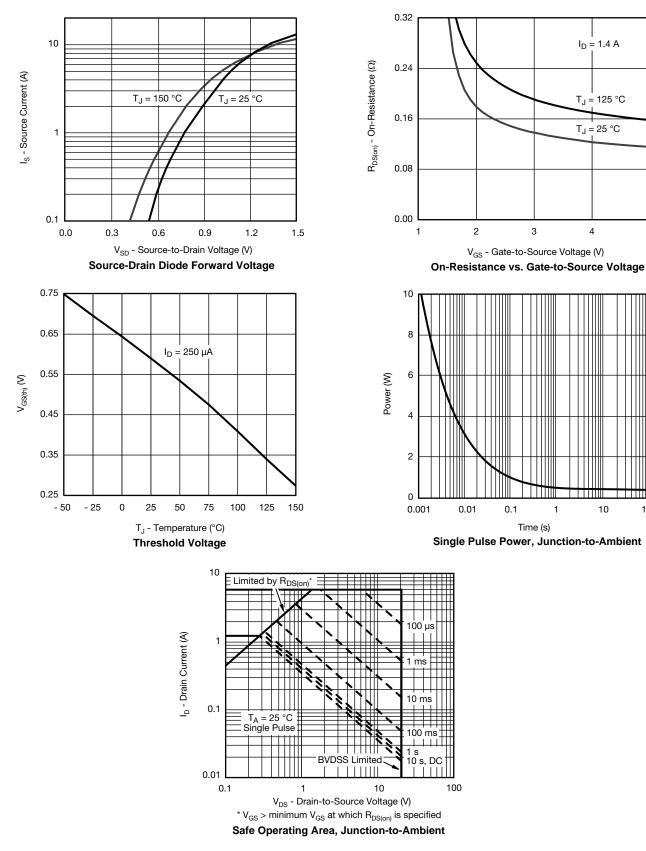
### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





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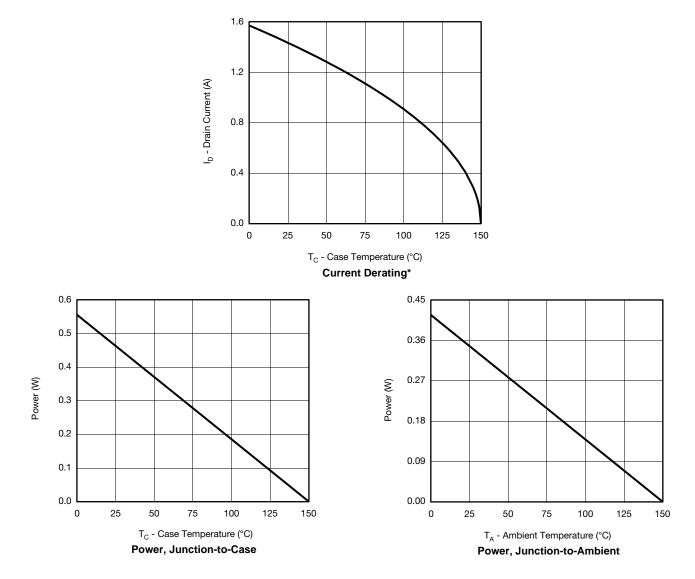
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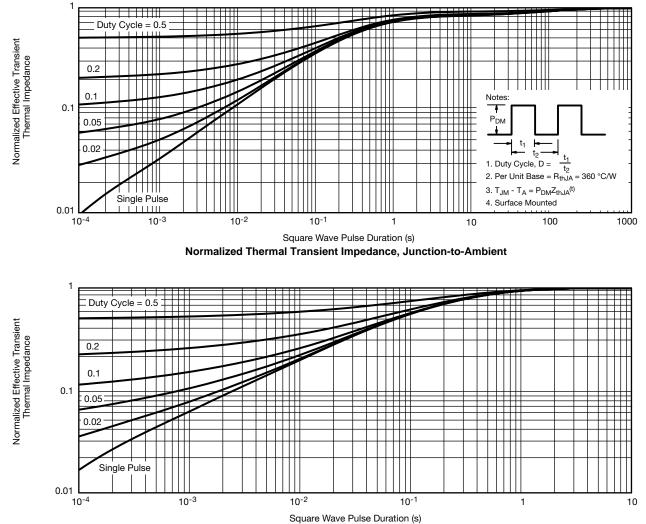


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\* The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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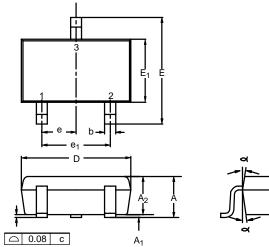


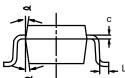
### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Normalized Thermal Transient Impedance, Junction-to-Foot



### SC-70: 3-LEADS

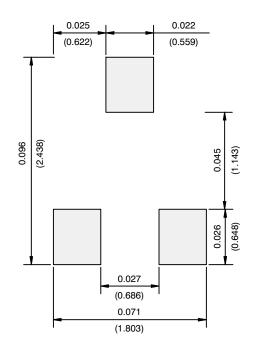




	MILLIMETERS			INCHES			
Dim	Min	Nom	Max	Min	Nom	Max	
Α	0.90	-	1.10	0.035	-	0.043	
<b>A</b> <sub>1</sub>	-	-	0.10	-	-	0.004	
A <sub>2</sub>	0.80	-	1.00	0.031	-	0.039	
b	0.25	-	0.40	0.010	-	0.016	
С	0.10	-	0.25	0.004	-	0.010	
D	1.80	2.00	2.20	0.071	0.079	0.087	
E	1.80	2.10	2.40	0.071	0.083	0.094	
E <sub>1</sub>	1.15	1.25	1.35	0.045	0.049	0.053	
е	0.65BSC			0.026BSC			
e <sub>1</sub>	1.20	1.30	1.40	0.047	0.051	0.055	
L	0.10	0.20	0.30	0.004	0.008	0.012	
٩	א 7°Nom			7°Nom			
ECN: S-03946—Rev. C, 09-Jul-01 DWG: 5549							



### **RECOMMENDED MINIMUM PADS FOR SC-70: 3-Lead**



Recommended Minimum Pads Dimensions in Inches/(mm)



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